# 2SA1123

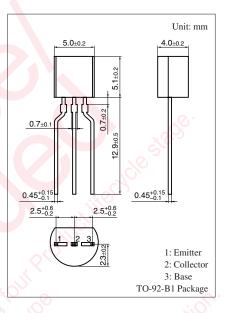
### Silicon PNP epitaxial planar type

For low-frequency high breakdown voltage amplification Complementary to 2SC2631

#### Features

- Satisfactory forward current transfer ratio  $h_{FE}$  collector current  $I_C$  characteristics.
- $\bullet$  High collector-emitter voltage (Base open)  $V_{\mbox{CEO}}$
- $\bullet$  Small collector output capacitance (Common base, input open circuited)  $C_{ob}$
- Makes up a complementary pair with 2SC2631, which is optimum for the pre-driver stage of a 20 W to 40 W output amplifier.

Absolute Maximum Ratings $T_a = 25^{\circ}C$							
Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-150	V				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-150	V				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-5	v.				
Collector current	I <sub>C</sub>	-50	mA				
Peak collector current	I <sub>CP</sub>	-100	mA				
Collector power dissipation	P <sub>C</sub>	750	mW				
Junction temperature	Tj	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C				



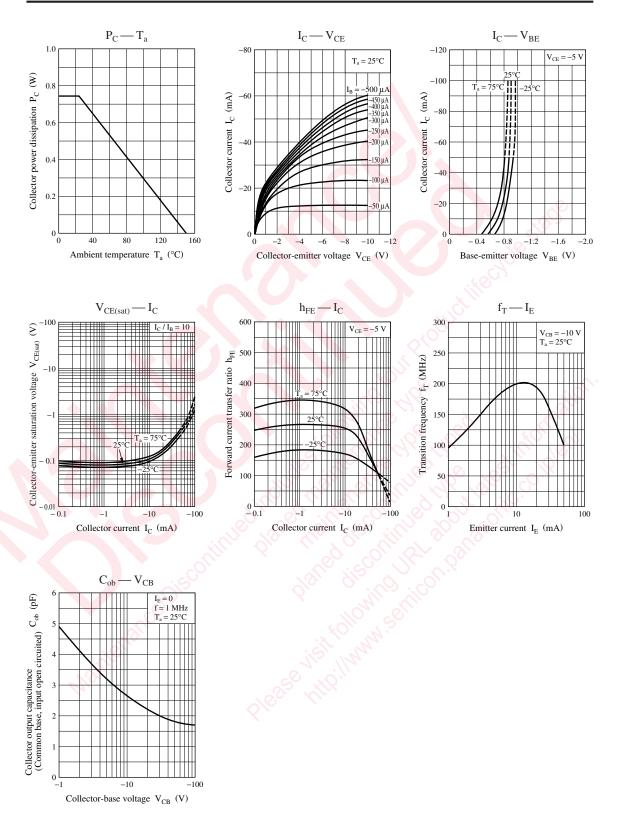
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

EO	$I_{\rm C} = -100 \ \mu A, I_{\rm B} = 0$	1.50			
	10 100 mil, 18	-150			V
во	$I_{\rm E} = -10 \ \mu A, I_{\rm C} = 0$	-5			V
во	$V_{CB} = -100 \text{ V}, I_E = 0$			-1	μΑ
Æ	$V_{CE} = -5 \text{ V}, I_{C} = -10 \text{ mA}$	130		450	
E(sat)	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = -3 \text{ mA}$			-1	V
г	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
ob	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$			5	pF
	6 <u>1</u> . 6		150	300	mV
	D 3 (sat)	$\begin{array}{c} & U_{CB} = -100 \text{ V}, I_E = 0 \\ & V_{CE} = -5 \text{ V}, I_C = -10 \text{ mA} \\ & I_C = -30 \text{ mA}, I_B = -3 \text{ mA} \\ & V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz} \\ & V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz} \end{array}$	$\begin{array}{c} & & & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ &$	$D_{CB} = -100 \text{ V}, I_E = 0$ 130 $D_{CE} = -5 \text{ V}, I_C = -10 \text{ mA}$ 130 $E_{CE} = -30 \text{ mA}, I_B = -3 \text{ mA}$ 130 $V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$ 200 $D_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ 150	$D_{CB} = -100 \text{ V}, \text{ I}_{E} = 0$ -1 $D_{CE} = -50 \text{ V}, \text{ I}_{C} = -10 \text{ mA}$ 130 450 $E_{E} = -30 \text{ mA}, \text{ I}_{B} = -3 \text{ mA}$ -1 $V_{CB} = -10 \text{ V}, \text{ I}_{E} = 10 \text{ mA}, \text{ f} = 200 \text{ MHz}$ 200 $V_{CB} = -10 \text{ V}, \text{ I}_{E} = 0, \text{ f} = 1 \text{ MHz}$ 5 $V_{CE} = -40 \text{ V}, \text{ I}_{C} = -1 \text{ mA}, \text{ G}_{V} = 80 \text{ dB}$ 150 300

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	S	Т
$\mathbf{h}_{\mathrm{FE}}$	130 to 220	185 to 330	260 to 450

## Panasonic



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